502744115 03/28/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Shunpei Yamazaki	11/02/2010
Jun Koyama	10/29/2010

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.	
Street Address:	398, HASE	
City:	ATSUGI-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	
Postal Code:	243-0036	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13779833

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	12732-0741002	
NAME OF SUBMITTER:	APRIL K. SAUNDERS-FULLER	
SIGNATURE:	/April K. Saunders-Fuller/	
DATE SIGNED:	03/28/2014	

Total Attachments: 1

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PATENT 502744115 REEL: 032552 FRAME: 0717

ASSIGNMENT

For valuable consideration, We, <u>Shunpei YAMAZAKI of Setagaya</u>, <u>Tokyo</u>, <u>Japan and Jun KOYAMA of Sagamihara</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF, filed 02/28/2013, and assigned U.S. Serial Number 13/779,833 , and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature

Name:

Shunpei YAMAZAKI

Date:

11/02/2010

Signature

Name:

RECORDED: 03/28/2014

Jun KOYAMA

Date:

10/29 /2010

PATENT REEL: 032552 FRAME: 0718